## **Tektronix**<sup>®</sup>

## **Certification of RoHS Compliance**

Issued: January 10, 2020

We

Tektronix, Inc P.O. Box 500 Beaverton, OR 97077

declare that

## **TBS2072B**

is compliant to Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment ('RoHS 2 Directive' or 'RoHS Recast'), as last amended prior to the date of issuance of this certificate.

RoHS Compliance means the part contains less than 0.1% by mass (1000 ppm) in homogeneous material for lead, mercury, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE), and less than 0.01% by mass (100 ppm) of homogeneous material for cadmium, unless used in an application that is specifically exempted by the Directive or its amendments.

Applicable exemptions:

• 6(a) Lead as an alloying element in steel for machining purposes and in galvanised steel containing up to 0.35 % lead by weight

- 6(b) Lead as an alloying element in aluminum containing up to 0.4 % lead by weight
- 6(c) Copper alloy containing up to 4 % lead by weight
- 7(a) Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)
  7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound
- 7(c)-II Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher
- 15 Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages
- 33 Lead in solders for the soldering of thin copper wires of 100 um diameter and less in power transformers
- The above exemption list may not be exhaustive. Inquire if further information is needed.

This certification is based on Tektronix' knowledge and belief as of the date of issue, and may rely in whole or in part on information provided by third-party suppliers of materials and components used in the manufacture of the designated part or product.

M.K.SP

M. R. Baggs, Product Compliance Manager, Tektronix Inc.